



Spin transfer torque in magnetic tunnel junctions with a wedge MgO barrier

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Outline

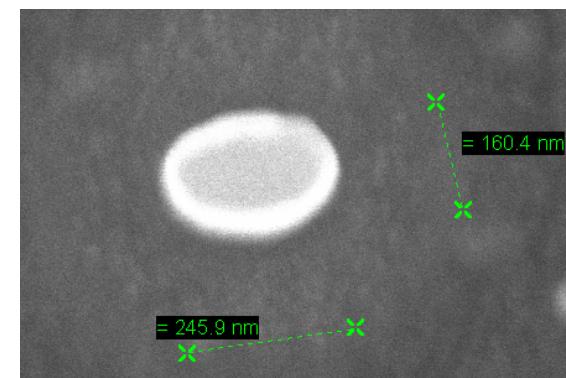
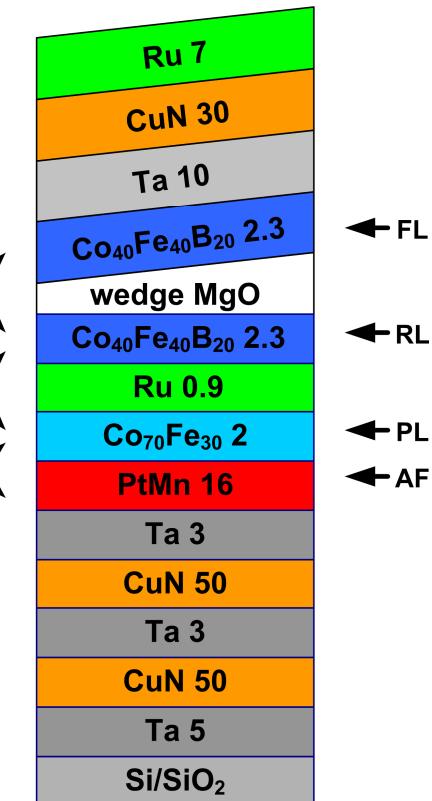
- Introduction
- Sample preparation
- Wafer level characterization
- Interlayer coupling
- Transport measurements – CIMS
- Conclusions

Introduction

- Aim:
 - To study the influence of a **MgO barrier thickness** (below 1 nm) in MTJs on the critical current density in CIMS

Sample preparation

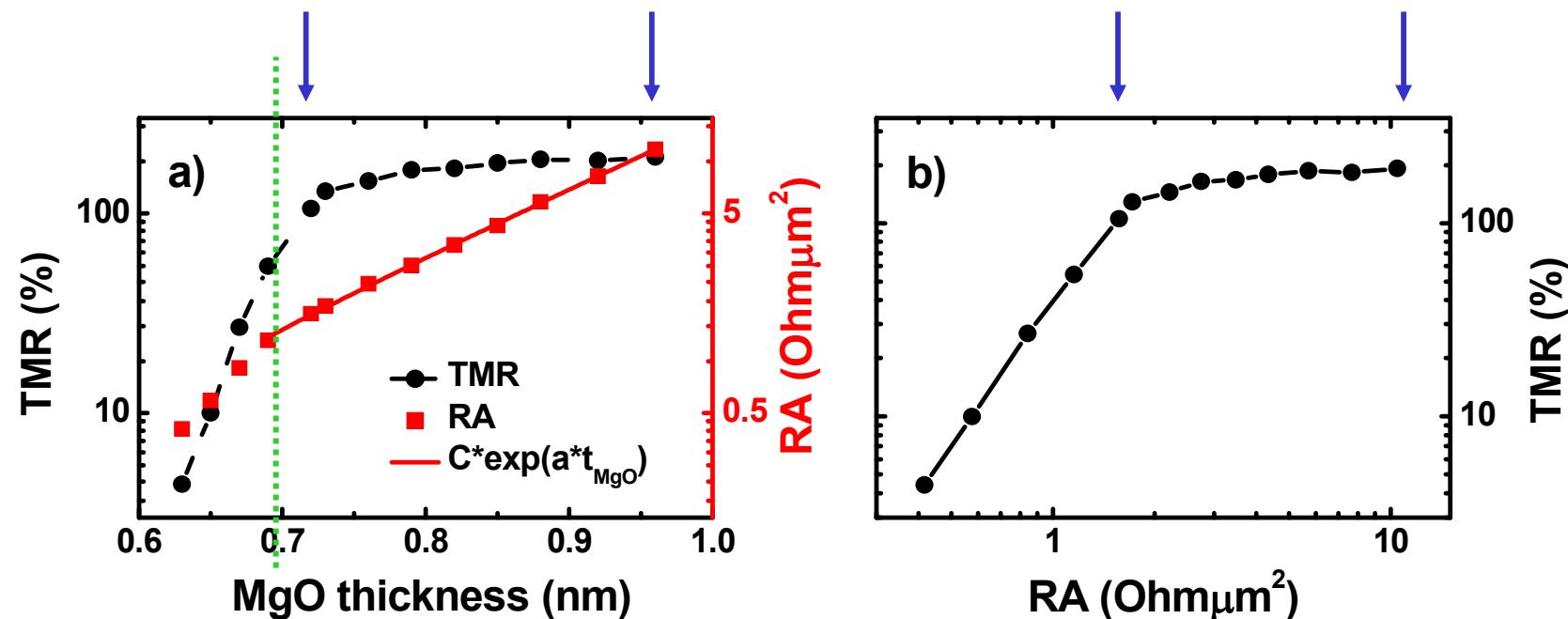
- MTJ stack deposited in Singulus Timaris PVD cluster tool system
- MgO wedge thickness: 0.62 nm up to 0.96 nm (slope 0.017 nm/cm)
- 2 step e-beam lithography, ion etching, lift-off
- 3 sizes of MTJs:
 - $0.03 \text{ } \mu\text{m}^2$ ($160 \times 250 \text{ nm}$)
 - $0.08 \text{ } \mu\text{m}^2$ ($280 \times 430 \text{ nm}$)
 - $0.13 \text{ } \mu\text{m}^2$ ($280 \times 620 \text{ nm}$)



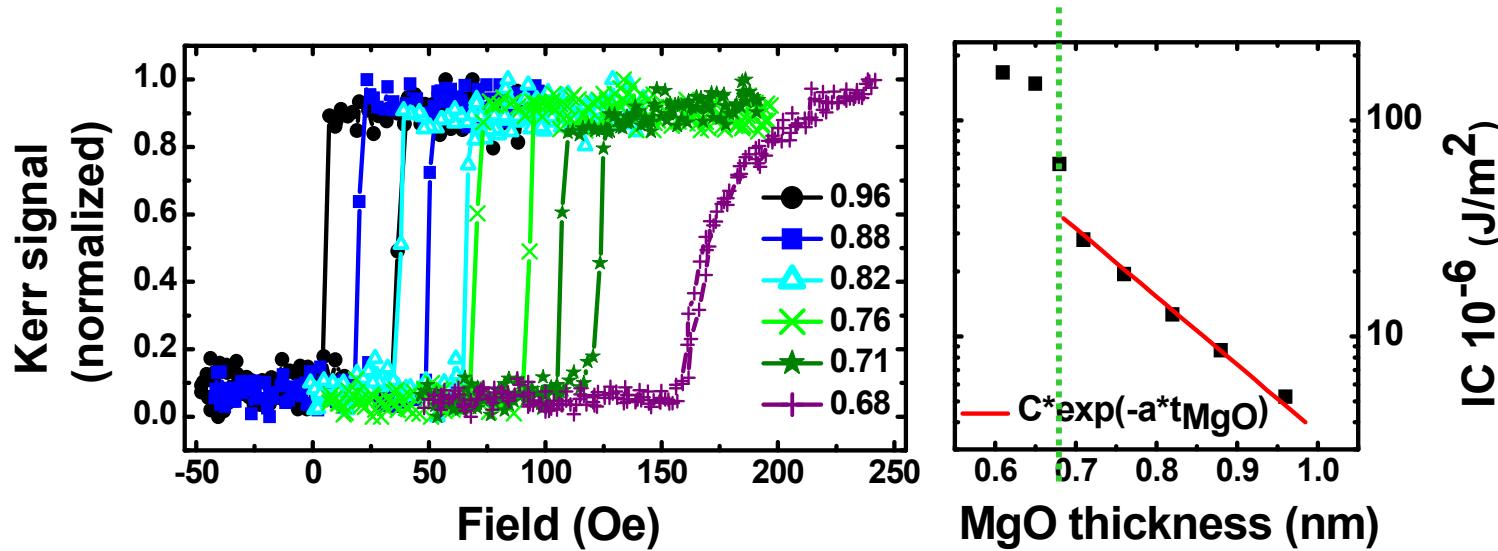
Wafer level characterization

- Measured using CIPT technique
- Small TMR change down to 0.75 nm MgO thickness
- When $RA < 1.5 \text{ Ohm}\cdot\mu\text{m}^2$ (0.7 nm MgO) TMR drops rapidly – barrier imperfection

Worledge et al.
APL **83**, 84, 2003

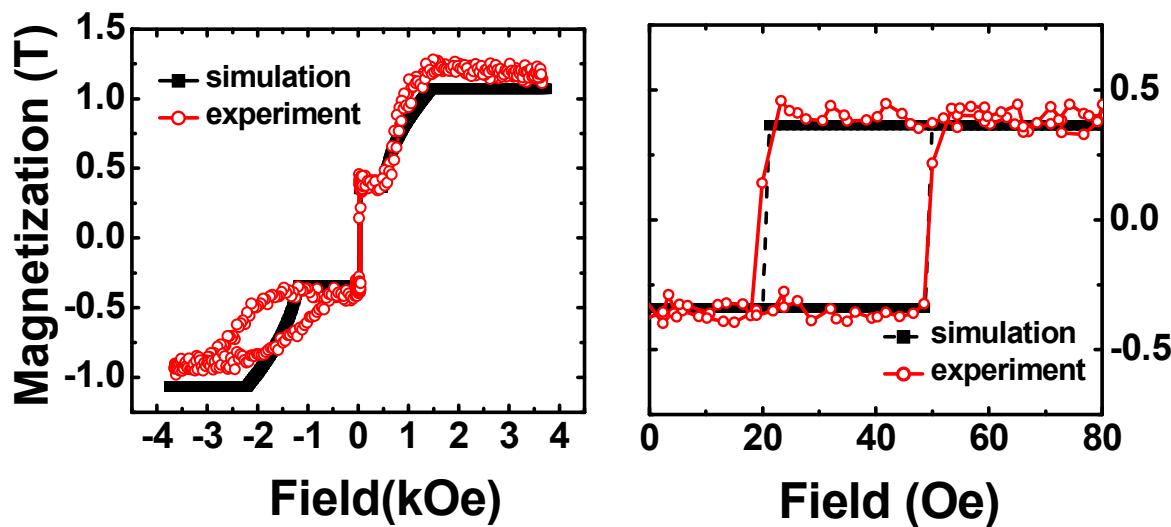


Interlayer coupling



J.Faure-Vincent et al. PRL **89**, 2002 and

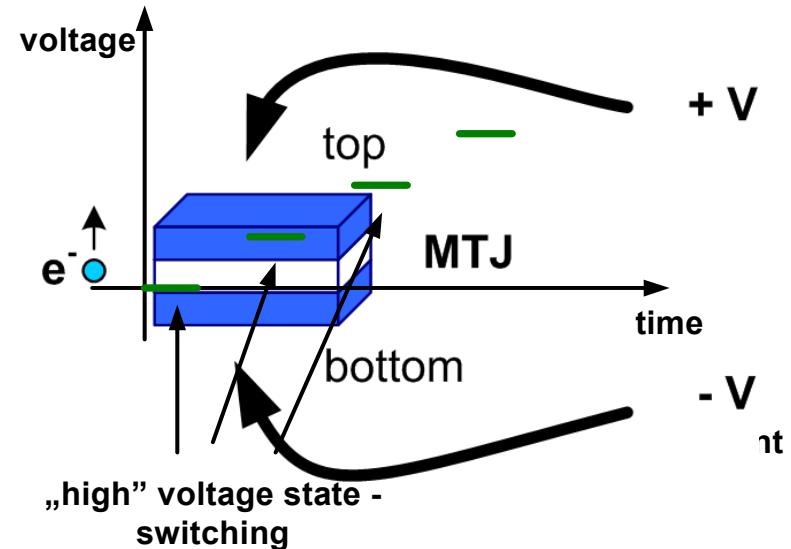
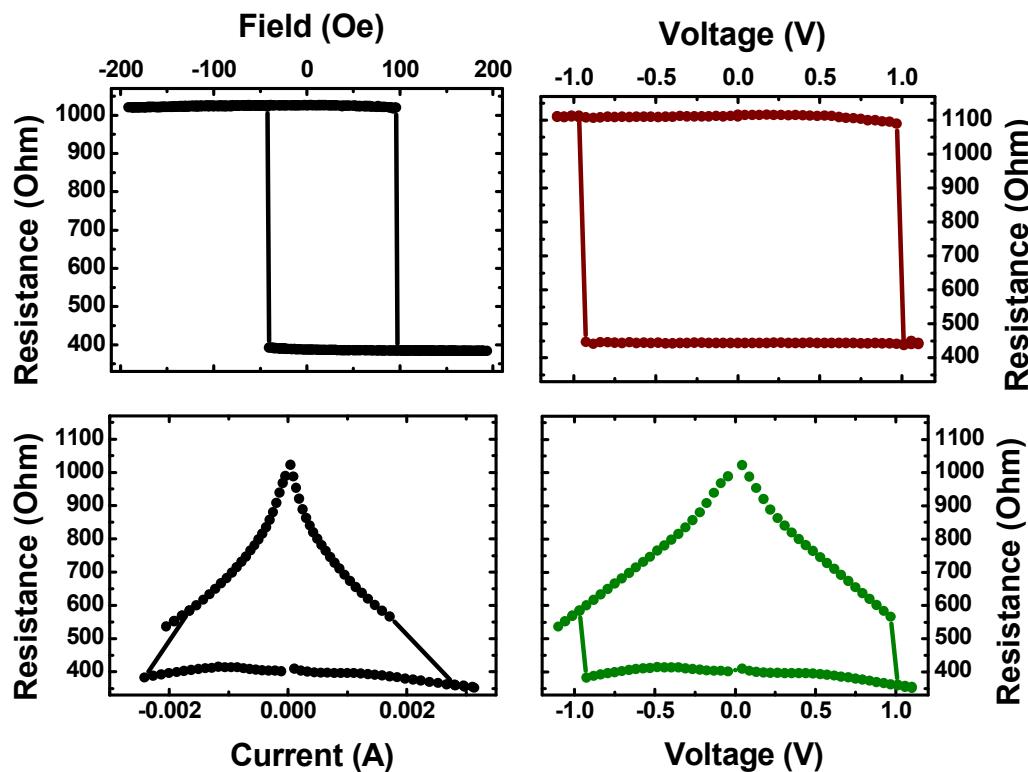
Katayama et al. APL **89**, 2006



- $\mu_0 M_{CoFeB} = \mu_0 M_{FL} = \mu_0 M_{RL} = \mathbf{1.35}$ T,
- $\mu_0 M_{CoFe} = \mu_0 M_{PL} = \mathbf{1.6}$ T,
- $K_{FL} = K_{RL} = \mathbf{940}$ J/m³
- $K_{PL} = \mathbf{100}$ J/m³
- $K_{AF} = \mathbf{60}$ kJ/m³
- $J_{SAF} = \mathbf{-0.221}$ mJ/m²
- $J_{EB} = \mathbf{0.188}$ mJ/m²

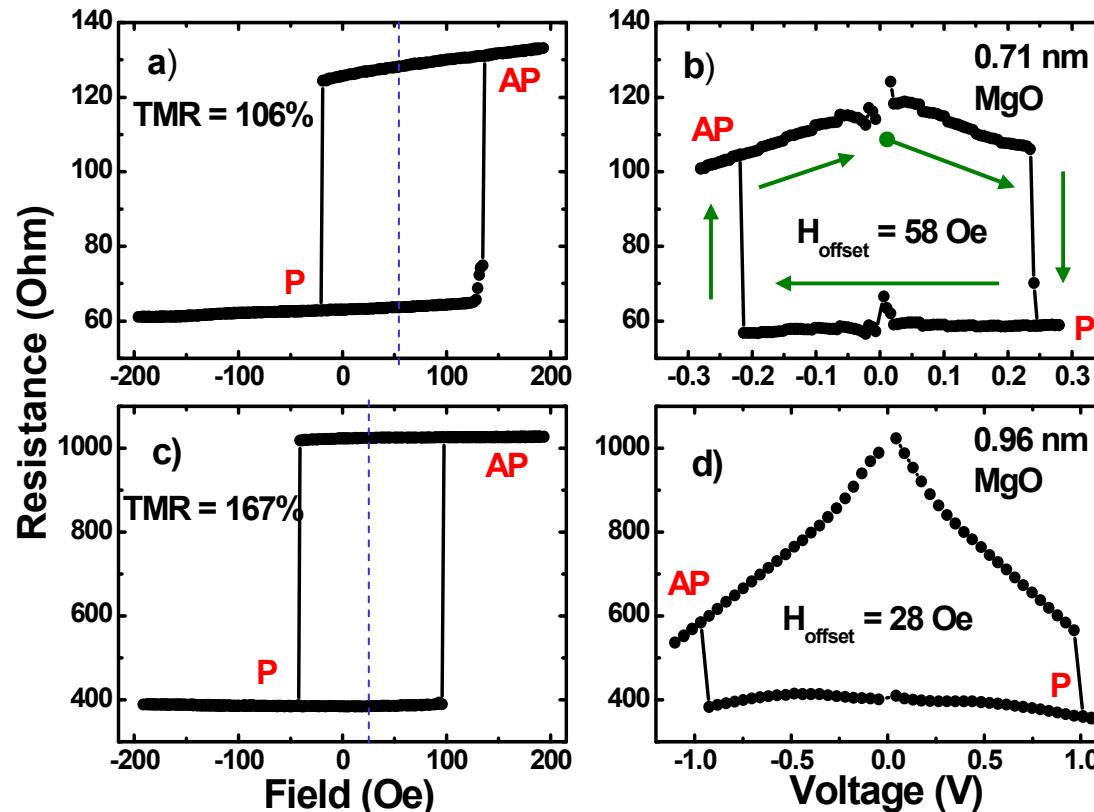
Transport measurements - methods

- 2 point contact method (lead and contact resistance negligably small < 2 Ohm)
- Voltage source, current measurement
- Pulse length of 400ms



Current induced switching - results

- For 0.71 nm MgO
AP->P
 $J_c = 7.3 \text{ MA/cm}^2$
P->AP
 $J_c = -12.5 \text{ MA/cm}^2$
- For 0.96 nm MgO
AP->P
 $J_c = 5.6 \text{ MA/cm}^2$
P->AP
 $J_c = -8 \text{ MA/cm}^2$



Itoh JPD **40**
1228, 2007

Current induced switching - model

- Slonczewski's model:

$$J_{c0} = \frac{2e\alpha\mu_0 M_S^2 t_F}{\hbar\eta}$$

$$\eta = \frac{p}{2(1 + p^2 \cos \theta)}$$

$$J_c = J_{c0} \left[1 - \frac{2k_B T}{M_S V} \cdot \frac{\ln\left(\frac{\tau_P}{\tau_0}\right)}{H_C} \right]$$

$M_S = 1.35 \text{ T}$
 $t_F = 2.3 \text{ nm}$
 $\text{area} = 0.03 \text{ } \mu\text{m}^2$
 $\alpha = 0.015$
 $\tau_P = 400 \text{ ms}$
 $H_C = 4 \text{ kA/m}$

		Exp. (MA/cm ²)	Calc. (MA/cm ²)
MgO 0.71 nm	AP->P	7.3	10.1
	P->AP	-12.5	-20.4
MgO 0.96 nm	AP->P	5.6	7.7
	P->AP	-8	-19.2

- Incorrect assymetry calculation
- Correlates TMR with STT (not really true)
- Better model needed

*Huai et al. JMMM **304** 88, 2006*

*Sankey et al. Nature Phys. **4** 783, 2008*

Summary

- Successful fabrication of MTJ nanopillars with a ultrathin MgO barrier
- IC increases with a decreasing MgO thickness
- The switching current asymmetry increases with a decreasing barrier thickness
- The critical current density is lower for a sample with a thicker MgO barrier (but the switching voltage is higher)

Colaborations

- Bielefeld University, prof. Reiss group
- Helsinki University of Technology, prof. Van Dijken group
- PTB Braunschweig, prof. Schumacher group

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Thank you for your attention.